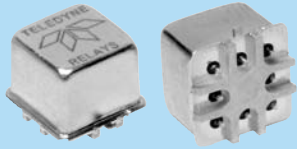




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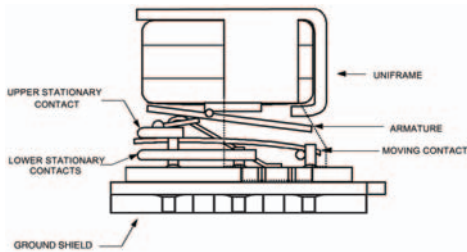


SERIES GRF172

SURFACE MOUNT, CENTIGRID® 2.5 GHz RF RELAYS DPDT

SERIES DESIGNATION	RELAY TYPE
GRF172	Surface mount, RF Centigrd® relay
GRF172D	Surface mount, RF Centigrd® relay with coil transient suppresson diode

INTERNAL CONSTRUCTION



DESCRIPTION

The GRF172 surface-mount Centigrd® relay is an ultraminiature, hermetically sealed, armature relay for 2.5 GHz RF applications. Its low profile height (.330") and .100" grid spaced terminals make it an ideal choice where extreme packaging density and/or close PC board spacing are required.

The GRF172 features a unique ground shield that isolates and shields each lead to ensure excellent contact-to-contact and pole-to-pole isolation. This ground shield provides a ground interface that results in improved high-frequency performance as well as parametric repeatability. The GRF172 extends performance advantages over similar RF devices that simply offer formed leads for surface mounting.

Unique construction features and manufacturing techniques provide overall high reliability and excellent resistance to environmental extremes:

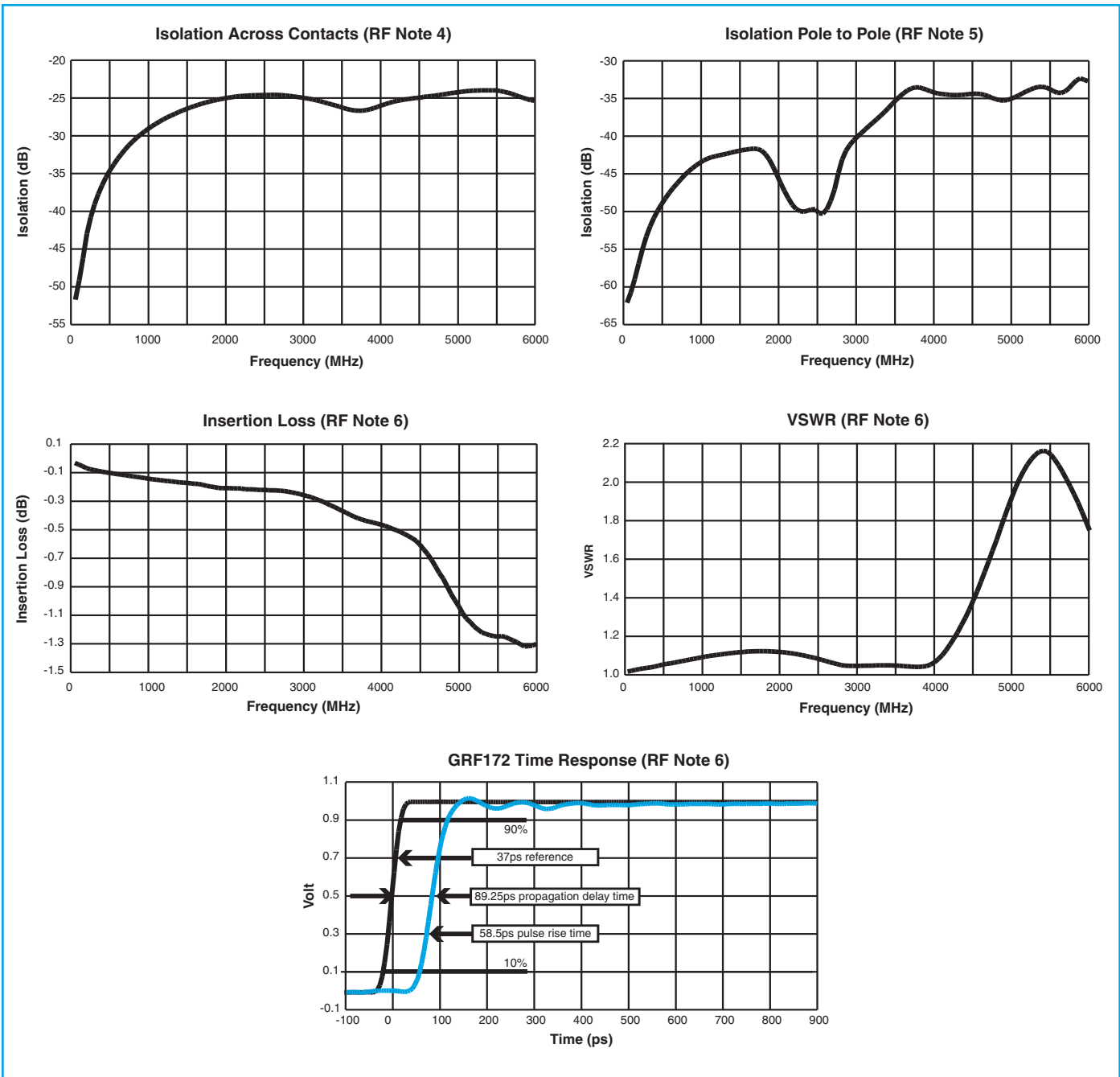
- All welded construction.
- Unique uni-frame design providing high magnetic efficiency and mechanical rigidity.
- High force/mass ratios for resistance to shock and vibration.
- Advanced cleaning techniques provide maximum assurance of internal cleanliness.
- Precious metal alloy contact material with gold plating assures excellent high current and dry circuit switching capabilities.

The Series GRF172D has an internal discrete silicon diode for coil transient suppression.

Applications include telecommunications, test instruments, mobile communications, attenuators, and automatic test equipment.

ENVIRONMENTAL AND PHYSICAL SPECIFICATIONS		
Temperature (Ambient)	Storage	-65°C to +125°C
	Operating	-55°C to +85°C
Vibration (General Note 1)		10 g's to 500 Hz
Shock (General Note 1)		30 g's, 6 msec, half-sine
Enclosure		Hermetically sealed
Weight		0.09 oz. (2.55g) max.

SERIES GRF172
TYPICAL RF CHARACTERISTICS (See RF Notes)



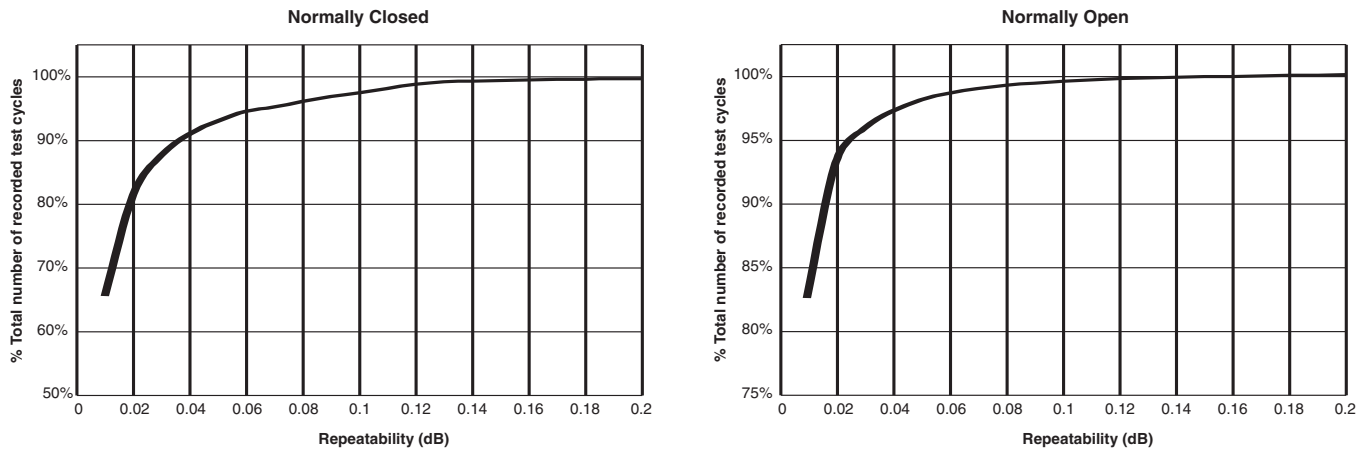
RF NOTES

1. Test conditions:
 - a. Fixture: .031" copper clad, reinforced PTFE, RT/duroid® 6002 with SMA connectors. (RT/duroid® is a registered trademark of Rogers Corporation.)
 - b. RF ground shield is soldered to PCB RF ground plane.
 - c. Room ambient temperature.
 - d. Terminals not tested were terminated with 50-ohm load.
 - e. Contact signal level: -10 dBm.
 - f. No. of test samples: 2.
2. Data presented herein represents typical characteristics and is not intended for use as specification limits.
3. Data is per pole, except for pole-to-pole data.
4. Data is the average from readings taken on all open contacts.
5. Data is the average from readings taken on poles with coil energized and de-energized.
6. Data is the average from readings taken on all closed contacts.
7. Test fixture effect de-embedded from frequency and time response data.

SERIES GRF172

TYPICAL RF INSERTION LOSS REPEATABILITY CHARACTERISTICS (See RF Insertion Loss Repeatability Notes)

REPEATABILITY CHARACTERISTICS GRF172 RELAYS



RF INSERTION LOSS REPEATABILITY NOTES

1. Test conditions:
 - a. Fixture: .031" copper clad, reinforced PTFE, RT/duroid® 6002 with SMA connectors. (RT/duroid® is a registered trademark of Rogers Corporation.)
 - b. Test performed at room ambient temperature.
 - c. Contact signal level: -10 dBm.
2. Data presented herein represents typical characteristics and is not intended for use as specification limits.
3. Insertion loss repeatability measured over frequency range from 50 MHz to 4 GHz.

SERIES GRF172
GENERAL ELECTRICAL SPECIFICATIONS (@25°C Notes 2 & 5)

Contact Arrangement	2 Form C (DPDT)
Rated Duty	Continuous
Contact Resistance	0.15 ohm max. before life; 0.3 ohm max. after life at 1A/28Vdc (measured 1/8" from header)
Contact Load Rating (DC) (See Fig. 1 for other DC resistive voltage/current ratings)	Resistive: 1 Amp/28Vdc Inductive: 100 mA/28Vdc (320 mH) Lamp: 100 mA/28Vdc Low Level: 10 to 50 μ A/10 to 50mV
Contact Life Ratings	5,000,000 cycles (typical) at low level 500,000 cycles (typical) at 0.5A/28Vdc resistive 100,000 cycles min. at all other loads specified above
Contact Overload Rating	2A/28Vdc Resistive (100 cycles min.)
Contact Carry Rating	Contact factory
Operate Time	6.0 msec max. at nominal rated coil voltage
Release Time	GRF172: 3.0 msec max. GRF172D: 6.0 msec max.
Intercontact Capacitance	0.4 pf typical
Insulation Resistance	1,000 megohms min. between mutually isolated terminals
Dielectric Strength	Atmospheric pressure: 350 Vrms/60Hz
Negative Coil Transient GRF172	2.0 Vdc Max.
Diode P.I.V. GRF172D	60 Vdc Min.

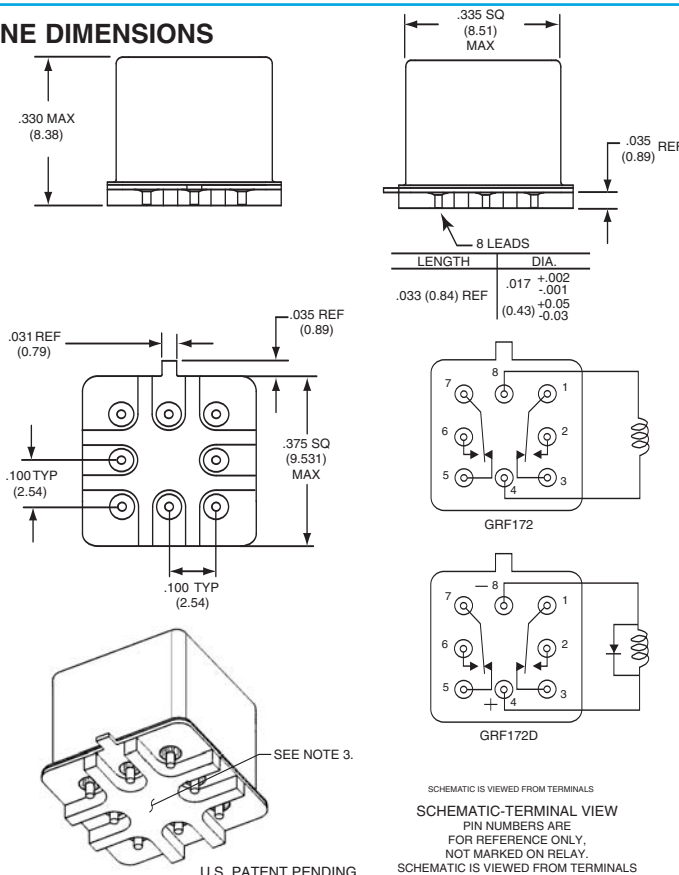
DETAILED ELECTRICAL SPECIFICATIONS (@25°C Note 2)

	BASE PART NUMBERS	GRF172-5 GRF172D-5	GRF172-12 GRF172D-12	GRF172-26 GRF172D-26
	Coil Voltage, Nominal (Vdc)	Nom.	5.0	12.0
	Max.	5.8	16.0	32.0
Coil Resistance (Ohms \pm20%)		64	400	1600
Pick-up Voltage (Vdc, Max.)		3.8	9.0	18.0
Coil Operating Power at Nominal Voltage (Milliwatts)		405	360	440

GENERAL NOTES

1. Relays will exhibit no contact chatter in excess of 10 μ sec or transfer in excess of 1 μ sec.
2. Unless otherwise specified, parameters are initial values.
3. Relays may be subjected to 260°C, peak solder reflow temperature, 1 minute, 3 passes.
4. Butt-lead ends are coplanar within .003" (0.08).
5. "Typical" characteristics are based on available data and are best estimates. No on-going verification tests are performed.
6. Application notes available for PCB layout and mounting information.

OUTLINE DIMENSIONS



NOTES:
 1. DIMENSIONS ARE IN INCHES. METRIC EQUIVALENTS IN MILLIMETERS ARE SHOWN IN ().
 2. UNLESS OTHERWISE SPECIFIED, TOLERANCES ON DIMENSIONS ARE \pm .010 INCH (0.025 mm).
 3. FOR OPTIMAL RF PERFORMANCE, SOLDER BOTTOM OF GROUND SHIELD TO PCB RF GROUND PLANE.